

08-28-01

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Attorney Docket No.: 4956-4

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UTILITY PATENT APPLICATION TRANSMITTAL

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(Only for new nonprovisional applications under 37 C.F.R. § 1.53(b))

Assistant Commissioner for Patents
BOX PATENT APPLICATION
Washington, DC 20231

Dated: August 27, 2001

Sir:

Transmitted herewith for filing is the utility patent application of:

Inventors: Xiaohui WANG, Longtu LI, Ji ZHOU, Zhengxing YUE, Zhenwei MA, Shuiyuan SU

For: A Material for Making Hyper Frequency Multi-Layer Chip Inductors with High Performance and Low Sintering Temperature and a Process for Preparing the Material

Enclosed are:

- Transmittal letter (2x) with Fee Computation Sheet
- General Authorization For Payment of Fees (2x)
- Title Page, Specification, Claims 1 to 5 & Abstract (30 pages [total number of pages of application])
- Executed Unexecuted Declaration and Power of Attorney (4 p.)
- 8 sheet(s) of drawing(s) (Figs. 1 to 14)
- Check for \$ 355 for filing fee
- Certified copy of priority document No(s). 00 123598.2
- Letter Transmitting Priority document
- Return Receipt Postcard

☐ Please charge my Deposit Account No. 03-2412 in the amount of \$. A duplicate copy of this sheet is enclosed.

☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this application or credit any overpayment to Deposit Acct. No. 03-2412.

☒ Any additional filing fees required under 37 CFR 1.16.

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- ☒ Any patent application processing fees under 37 CFR 1.17
- ☒ The issue fee set in 37 CFR 1.18 at 3 months from mailing of the Notice of Allowance, pursuant to 37 CFR 1.311 (b) provided the fee has not already been paid by check.
- ☒ Any filing fees under 37 CFR 1.16 for presentation of extra claims.

☒ Priority is claimed for this invention and application, corresponding applications having been filed in **China** on **August 25, 2000**, No. **00 123598.2**.

Respectfully submitted,
COHEN, PONTANI, LIEBERMAN & PAVANE

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FILING FEE COMPUTATION SHEET

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In re Application of: Xiaohui WANG et al.

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The filing fee has been calculated as shown below:

FOR:	Col. 1	Col. 2	SMALL ENTITY	OTHER THAN SMALL ENTITY
	# FILED	# EXTRA		
BASIC FEE			\$355	\$710
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INDEPENDENT CLAIMS	<u>1</u> - 3 =		x 40 = \$ 0	x 80 = \$
<input type="checkbox"/> MULTIPLE DEPENDENCY			+\$135 = \$ 0	+ 270 \$
* If the difference in Col. 1 is less than zero, enter "0" in Col. 2			TOTAL: \$ 355	\$